bq2902

# Rechargeable Alkaline Charge/Discharge Controller IC

### **Features**

### **General Description**

 Safely charges two rechargeable alkaline batteries such as Renewal<sup>®</sup> from Rayovac<sup>®</sup>

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- ► Terminates pulsed charge with maximum voltage limit
- Contains LED charge status output
- Features a pin-selectable low-battery cut-off
- Pre-charge qualification indicates fault condition
- Available in 8-pin 300-mil DIP or 150-mil SOIC

The bq2902 is a low-cost charger for rechargeable alkaline batteries such as Renewal® batteries from Rayovac®. The bq2902 combines sensitive, fullcharge detection for two rechargeable alkaline cells, with a low-battery cut-off for overdischarge protection.

Designed for system integration into a two-cell system, the bq2902 can improve the service life of the rechargeable alkaline cells by properly managing the charge and discharge. The bq2902 requires a voltage limited current source to generate the proper charge pulses for the Renewal<sup>®</sup> cell. Each cell is individually monitored to ensure full charge without a damaging overcharge. Charge completion is indicated when the average charge rate falls below approximately 3% of the fast charge rate. A status output is provided to indicate charge in progress, charge complete, or fault indication.

The bq2902 avoids over-depleting the battery by using the internal end-of-discharge control circuit. The bq2902 also eliminates the external power switching transistors needed to separately charge individual Renewal cells.

For safety, charging is inhibited if the per-cell voltage is greater than 3.0V during charge (closed-circuit voltage), or if the cell voltage is less than 0.4V (open-circuit voltage).

### **Pin Connections**



### **Pin Names**

DC	Charging supply input	V <sub>SS</sub>	Battery 2 negative input
CHG	Battery status output		ie ground
BAT <sub>1P</sub>	Battery 1 positive input	LRTN	System load return
		VSEL	End-of-discharge voltage
BAT <sub>1N</sub>	Battery 1 negative input		select input

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### **Pin Descriptions**

#### DC DC supply input

This input is used to charge the rechargeable alkaline cells and power the bq2902 during charge. To charge the batteries, this input should be connected to a current-source limited to 300 mA. If the DC input current is greater than 300mA, the power dissipation limits of the package may be exceeded. The DC input should also be capable of supplying a minimum of 3.3V and should not exceed 5.5V.

#### CHG Charge status

This open-drain output is used to signify the battery charging status and is valid only when DC is applied.

#### V<sub>SEL</sub> End-of-discharge select input

This three-level input selects the desired end-of-discharge cut-off voltage for the bq2902.  $V_{SEL}$  = BAT<sub>1P</sub> selects an EDV of 1.10V.  $V_{SEL}$  floating selects EDV = 1.0V.  $V_{SEL}$  =  $V_{SS}$  selects EDV = 0.9.V

#### BAT<sub>1P</sub> Battery 1 positive input

This input connects to the positive terminal of the battery designated  $BAT_1$  (see Figure 3). This pin also provides power to the bq2902 when DC is not present.

#### $BAT_{1N}$ Battery 1 negative input

This input connects to the negative terminal of the battery designated  $BAT_1$  (see Figure 3).

#### V<sub>SS</sub> Battery 2 negative input/IC ground

This input connects to the negative terminal of the battery designated  $BAT_2$  (see Figure 3).

#### LRTN Load return

This open-drain pull-down output is typically used as a low-side switch. High-side load switching is also possible with the addition of an external P-FET.

### **Functional Description**

Figure 1 is a block diagram outlining the major components of the bq2902.

Figure 2 illustrates the charge control and display status during a bq2902 cycle. Table 1 outlines the vari-



Figure 1. Functional Block Diagram

ous operational states and their associated conditions which are described in detail in the following section. Figure 3 is an application example.

#### **Charge Initiation**

The bq2902 always initiates and performs a charge cycle whenever a valid DC input is applied. A charge cycle consists of pulse charging the battery and then checking for a termination condition. The charging section explains charging in greater detail.

#### **Charge Pre-Qualification**

After DC is applied, the bq2902 checks the open-circuit voltage ( $V_{OCV}$ ) of each cell for an undervoltage condition ( $V_{MIN}$  = 0.4V) and begins a charge cycle when the  $V_{OCV}$  of all cells is above  $V_{MIN}$ . If  $V_{OCV}$  of any cell is below  $V_{MIN}$ , the bq2902 enters a charge-pending mode and indicates a fault condition (see Table 1). The bq2902 remains in a charge-pending mode until  $V_{OCV}$  of each cell is above  $V_{MIN}$ .

#### **Charge Termination**

Once a charge cycle begins, the bq2902 terminates charge when the average charge rate falls below 3% of the maximum charge rate. The bq2902 also terminates charge when the closed-circuit voltage (V<sub>CCV</sub>) of any cell exceeds 3.0V (V<sub>FLT</sub>) during charge and indicates a fault condition on the CHG output (see Table 1).

#### **Charge Re-Initiation**

If DC remains valid, the bq2902 suspends all charge activity after full-charge termination. A charge cycle is re-initiated when all cell potentials fall below 1.4V. The rechargeable alkaline cells, unlike other rechargeable chemistries, do not require a maintenance charge to keep the cells in a fully charged state. The self-discharge rate for the Renewal cells is typically 4% per year at room temperature.

#### **Charge Status Indication**

Table 1 and Figure 2 outline the various charge action states and the associated  $BAT_{1P}$ , and  $\overline{CHG}$  output states. The charge status output is designed to work with an LED indicator. In all cases, if DC is not present at the DC pin, or if the DC supply is less than the voltage at the  $BAT_{1P}$  pin, the CHG output is held in a high-impedance condition.

#### Charging

The bq2902 controls charging by periodically connecting the DC current-source to the battery stack, not to the individual battery cells. The charge current is pulsed from the internal clock at approximately a 80Hz rate on the BAT<sub>1P</sub> pin.

The bq2902 pulse charges the battery for approximately 10ms of every 12.5ms, when conditions warrant. The bq2902 measures the open-circuit voltage ( $V_{OCV}$ ) of each battery cell during the idle period. If a single-cell poten-

#### Table 1. bq2902 Operational Summary

Charge Action State	Conditions	BAT <sub>1P</sub> Input	CHG Output
DC absent	$V_{\rm DC} < V_{\rm BAT1P}$	Low battery detection per $V_{\rm SEL}$	Z
Charge initiation	DC applied	-	-
Charge pending/ fault	$V_{\rm OCV}$ < $0.4V^1$ or $V_{\rm CCV}$ > $3.0V^2$	-	$\frac{2}{3} \sec = Low$ $\frac{2}{3} \sec = Z$
Charge pulse	$V_{OCV} \le 1.63V$ before pulse	Charge pulsed @ 80Hz per Figure 2	$\frac{1}{6} \sec = Low$ $\frac{1}{6} \sec = Z$
Pulse skip	V <sub>OCV</sub> > 1.63V before pulse	Pulse skipped per Figure 2	$\frac{1}{6} \sec = Low$ $\frac{1}{6} \sec = Z$
Charge complete	Average charge rate falls below 3% of the fast charge rate	Charge complete	Low

Notes: 1. V<sub>OCV</sub> = Open-circuit voltage of each cell between positive and negative leads.

<sup>2.</sup> V<sub>CCV</sub> = Closed-circuit voltage.

tial of any battery is above the maximum open-circuit voltage (V<sub>MAX</sub> = 1.63V ±3%), the following pulses are skipped until all cell potentials fall below the V<sub>MAX</sub> limit. Charging is terminated when the average charge rate falls below approximately 3% of the maximum charge rate. Once charging is terminated, the internal charging FET remains off, and the CHG output becomes active per Table 1 and Figure 2. With DC applied, the internal discharge FET will always remain on.

#### End-of-Discharge Control

When DC is not present or less than the voltage present on the BAT<sub>1P</sub> pin, the bq2902 power is supplied by the voltage present at the BAT<sub>1P</sub> pin. In this state, the batteries discharge down to the level determined by the  $V_{\rm SEL}$  pin. The bq2902 monitors the cell voltage of the rechargeable alkaline cells.

If the voltage across any cell is below the voltage specified by the V\_{SEL} input, the bq2902 disconnects the battery stack from the load by turning the internal discharge FET off. The discharge FET remains off until either the batteries are replaced or DC is reapplied, initiating a new charge cycle. After disconnecting the battery stack from the load, the standby current in the bq2902 is reduced to less than 1 $\mu$ A. The end-of-

discharge voltage ( $V_{EDV}$ ) is selectable by connecting the  $V_{SEL}$  pin as outlined in Table 2. Typically, higher discharge loads (>200mA) should use a lower discharge voltage cut-off to maximize battery capacity.

#### Table 2. bq2902 EDV Selections

End-of-Discharge Voltage	Pin Connection
1.10V	$V_{\rm SEL}$ = ${\rm BAT}_{1{\rm P}}$
1.00V	$V_{\rm SEL}$ = Z
0.90V	$V_{\rm SEL}$ = $V_{\rm SS}$



Figure 2. bq2902 Application Diagram

# bq2902



Figure 3. bq2902 Application Example, 1.0V EDV

### **Absolute Maximum Ratings**

Symbol	Parameter	Minimum	Maximum	Unit	Notes
DCIN	V <sub>DC</sub> relative to GND	-0.3	7.0	V	
VT	DC threshold voltage applied on any pin, excluding the DC pin, relative to GND	-0.3	7.0	V	
m		0	+70	°C	Commercial
TOPR	Operating ambient temperature	-40	+85	°C	Industrial
$T_{\mathrm{STG}}$	Storage temperature	-40	+85	°C	
TSOLDER	Soldering temperature	-	+260	°C	10 sec max.
I <sub>DC</sub>	DC charging current	-	400	mA	
ILOAD	Discharge current	-	500	mA	
I <sub>OL</sub>	Output current	-	-	mA	CHG

**Note:** Permanent device damage may occur if **Absolute Maximum Ratings** are exceeded. Functional operation should be limited to the Recommended DC Operating Conditions detailed in this data sheet. Exposure to conditions beyond the operational limits for extended periods of time may affect device reliability.

# **DC Thresholds** (T<sub>A</sub> = 25°C; V<sub>DC</sub> = 5.5V)

Symbol	Parameter	Rating	Tolerance	Unit	Notes
V <sub>MAX</sub>	Maximum open-circuit voltage	1.63	±3%	v	$V_{OCV} > V_{MAX}$ inhibits/terminates charge pulses
		0.90	$\pm 5\%$	V	$V_{SEL} = BAT_{2N}$
V <sub>EDV</sub>	End-of-discharge voltage	1.00	$\pm 5\%$	V	$V_{SEL} = Z$
		1.10	$\pm 5\%$	V	$V_{\rm SEL} = BAT_{1P}$
V <sub>FLT</sub>	Maximum open-circuit voltage	3.00	$\pm 5\%$	v	$V_{\rm CCV}$ > $V_{\rm FLT}$ terminates charge, indicates fault
V <sub>MIN</sub>	Minimum battery voltage	0.40	$\pm 5\%$	V	$V_{OCV} < V_{MIN}$ inhibits charge
V <sub>CE</sub>	Charge enable	1.40	$\pm 5\%$	V	$V_{OCV} < V_{CE}$ on both cells reinitiates charge

Note:

Each DC threshold parameter above has a temperature coefficient associated with it. To determine the coefficient for each parameter, use the following formula:

$$Tempco = \frac{ParameterRating}{1.63} * -0.5 \text{mV/°C}$$

The tolerance for these temperature coefficients is 10%.

# Timing (T<sub>A</sub> = T<sub>OPR</sub>)

Symbol	Parameter	Minimum	Typical	Maximum	Unit	Notes
tP	Pulse period	-	12.5	-	ms	See Figure 2
$t_{\rm PW}$	Pulse width	-	10	-	ms	See Figure 2

Note: Typical is at  $T_A = 25^{\circ}C$ .

## **DC Electrical Characteristics** (TA = TOPR)

Symbol	Parameter	Minimum	Typical	Maximum	Unit	Notes
V <sub>IH</sub>	Logic input high	V <sub>BAT1P</sub> - 0.1	-	V <sub>BAT1P</sub>	V	V <sub>SEL</sub>
VIL	Logic input low	$V_{\rm SS}$	-	$V_{\rm SS}$ + 0.1	v	VSEL
VOL	Logic output low	-	-	0.8	v	$I_{OL} = 10 mA$
IOL	Output current	10	-	-	mA	$@V_{OL} = V_{SS} + 0.8V$
I <sub>CC</sub>	Supply current	-	-	250	μA	Outputs unloaded, $V_{DC} = 5.5 V$
I <sub>SB1</sub>	Standby current	-	-	25	μA	$V_{DC} = 0V, V_{OCV} > V_{EDV}$
$I_{\rm SB2}$	End-of-discharge standby current	-	-	1	μA	VDC = 0V
$I_{\rm L}$	Input leakage	-	-	$\pm 1$	μA	V <sub>SEL</sub>
I <sub>OZ</sub>	Output leakage in high-Z state	-5	-	-	μA	CHG
R <sub>DSON</sub>	On resistance	-	0.5	-	Ω	Discharge FET; $V_{BAT1P} = 1.8V$
I <sub>IL</sub>	Logic input low	-	-	70	μA	VSEL
I <sub>IH</sub>	Logic input high	-70	-	-	μA	V <sub>SEL</sub>
I <sub>IZ</sub>	Logic input float	-2	-	2	μA	VSEL
I <sub>DC</sub>	DC charging current	-	-	300	mA	
V <sub>DC</sub>	DC charging voltage	3.3	-	5.5	v	DC
ILOAD	Discharge current	-	-	400	mA	
VOP	Operating voltage	1.8	-	5.5	V	BAT <sub>1P</sub>

# 8-Pin DIP (PN)





## 8-Pin PN (0.300" DIP)

	Inches		Millin	Millimeters	
Dimension	Min.	Max.	Min.	Max.	
Α	0.160	0.180	4.06	4.57	
A1	0.015	0.040	0.38	1.02	
В	0.015	0.022	0.38	0.56	
B1	0.055	0.065	1.40	1.65	
С	0.008	0.013	0.20	0.33	
D	0.350	0.380	8.89	9.65	
Е	0.300	0.325	7.62	8.26	
E1	0.230	0.280	5.84	7.11	
е	0.300	0.370	7.62	9.40	
G	0.090	0.110	2.29	2.79	
L	0.115	0.150	2.92	3.81	
S	0.020	0.040	0.51	1.02	

# 8-Pin SOIC Narrow (SN)





	Inc	hes	Millin	neters
Dimension	Min.	Max.	Min.	Max.
Α	0.060	0.070	1.52	1.78
A1	0.004	0.010	0.10	0.25
В	0.013	0.020	0.33	0.51
C	0.007	0.010	0.18	0.25
D	0.185	0.200	4.70	5.08
Е	0.150	0.160	3.81	4.06
e	0.045	0.055	1.14	1.40
Н	0.225	0.245	5.72	6.22
L	0.015	0.035	0.38	0.89

### 8-Pin SN (0.150" SOIC)

## **Data Sheet Revision History**

Change No.	Page No.	Description	Nature of Change
1	2	Figure 1. Functional Block Diagram	Updated block diagram

Notes: Change 1 = May 1999 C changes from Jan. 1997 B.

## **Ordering Information**



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